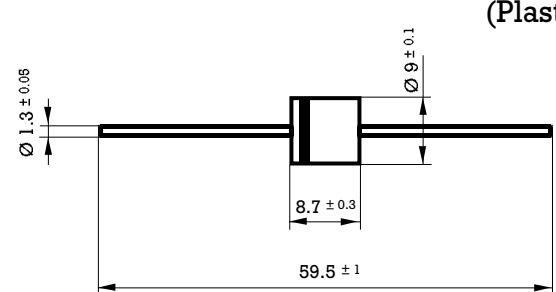



5 Amp. Glass Passivated Fast Recovery Rectifier

<p>Dimensions in mm.</p> <p style="text-align: right;">P-6 (Plastic)</p>  <p>Mounting instructions</p> <ol style="list-style-type: none"> 1. Min. distance from body to soldering point, 4 mm. 2. Max. solder temperature, 350 °C. 3. Max. soldering time, 3.5 sec. 4. Do not bend lead at a point closer than 4 mm. to the body. 	<p>Voltage 50 to 600 V.</p> <p>Current 5.0 A. at 55 °C.</p>  <ul style="list-style-type: none"> • Glass passivated junction • Fast Recovery Diodes • High current capability • The plastic material carries U/L recognition 94 V-0 • Terminals: Axial Leads • Polarity: Color band denotes cathode
---	--

Maximum Ratings, according to IEC publication No. 134

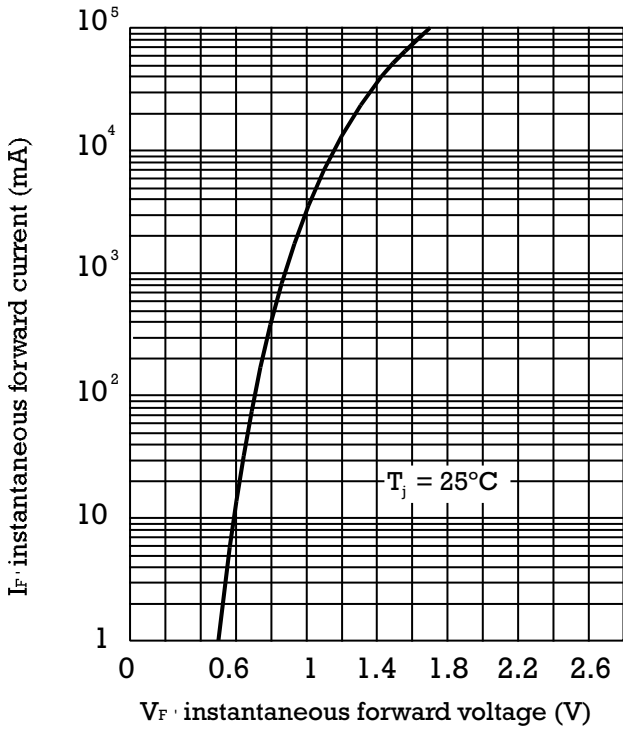
		MR820	MR821	MR822	MR824	MR826
V_{RRM}	Peak recurrent and non recurrent reverse voltage (V)	50	100	200	400	600
$I_{F(AV)}$	Forward current at $T_{amb} = 55\text{ °C}$	5 A				
I_{FRM}	Recurrent peak forward current (A)	60 A				
I_{FSM}	8.3 ms. peak forward surge current (Jedec Method)	300 A				
t_{rr}	Max. reverse recovery time from $I_F = 0.5\text{ A}$ $I_R = 1\text{ A}$ $I_{RR} = 0.25\text{ A}$	150 ns				
T_j	Operating temperature range	- 65 to + 175 °C				
T_{stg}	Storage temperature range	- 65 to + 175 °C				
E_{RSM}	Maximum non repetitive peak reverse avalanche energy. $I_R = 1\text{ A}$; $T_j = 25\text{ °C}$	20 mJ				

Electrical Characteristics at $T_{amb} = 25\text{ °C}$

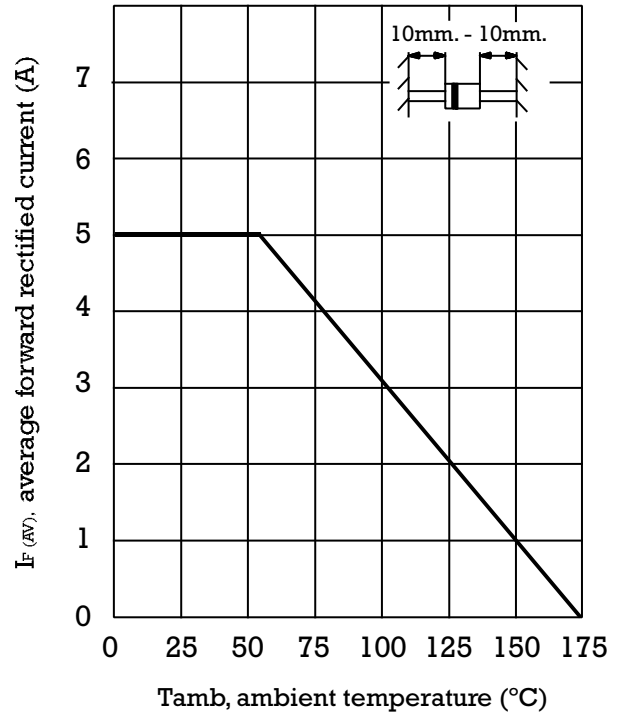
V_F	Max. forward voltage drop at $I_F = 5\text{ A}$	1.2 V
I_R	Max. reverse current at V_{RRM} at 25 °C	5 $\mu\text{ A}$
R_{thj-a}	Max. thermal resistance ($I = 10\text{ mm.}$)	10 °C/W

Rating and Characteristic Curves

TYPICAL FORWARD CHARACTERISTIC



FORWARD CURRENT DERATING CURVE



MAXIMUM NON REPETITIVE PEAK FORWARD SURGE CURRENT

